

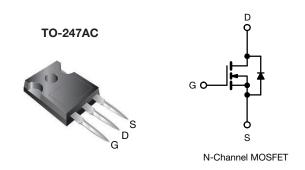
Vishay Siliconix

COMPLIANT

HALOGEN

**FREE** 

# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.135		
Q <sub>g</sub> max. (nC)	36			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	6			
Configuration	Single			

#### **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG150N60E-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600	V	
Gate-source voltage			$V_{GS}$	± 30	7 °	
Continuous drain current (T <sub>J</sub> = 150 °C)	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I <sub>D</sub>	22	А	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		14		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	43		
Linear derating factor				1.42	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	111	mJ	
Maximum power dissipation			P <sub>D</sub>	179	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope		T <sub>J</sub> = 125 °C	125 °C 100		1//	
Reverse diode dv/dt <sup>d</sup>		dv/dt	5	- V/ns		
Soldering recommendations (peak temperature) <sup>c</sup> For 10 s			260	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 2.8 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	=	40	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.7	C/VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.62	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	5.0	V
Octo comes laslesse	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V		-	± 100	nA
Gate-source leakage		,	V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
Zana mata walta aa ahaa'a awaant		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A	-	0.135	0.155	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A		-	5.1	-	S
Dynamic		-					
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	1514	-	
Output capacitance	C <sub>oss</sub>	Π,	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		60	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 100 KHz		-	2	-	pF
Effective output capacitance, energy related	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		-	58	-	
Effective output capacitance, time related	C <sub>o(tr)</sub>			-	322	-	
Total gate charge	Qg			-	24	36	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 480 \text{ V}$		10	-	nC
Gate-drain charge	Q <sub>gd</sub>	1			6	-	
Turn-on delay time	t <sub>d(on)</sub>	<u> </u>		-	20	40	- ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD} = 480 \text{ V}, I_D = 10 \text{ A},$ $V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		27	54	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =			28	56	
Fall time	t <sub>f</sub>			-	17	34	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.4	0.9	1.8	Ω
<b>Drain-Source Body Diode Characteristic</b>		-					
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	
Pulsed diode forward current	I <sub>SM</sub>			-	-	43	Α
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 10 \text{A},$ $di/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	291	582	ns
Reverse recovery charge	Q <sub>rr</sub>			-	3.5	7.0	μC
Reverse recovery current	I <sub>RRM</sub>			_	21	_	A



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

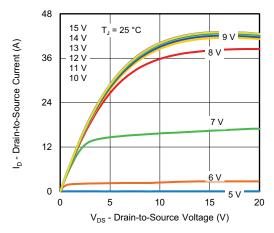


Fig. 1 - Typical Output Characteristics

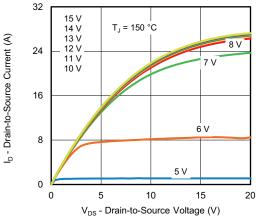


Fig. 2 - Typical Output Characteristics

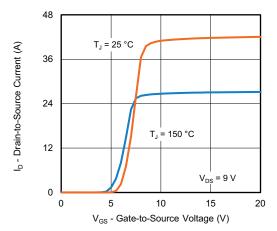


Fig. 3 - Typical Transfer Characteristics

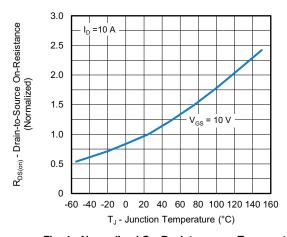


Fig. 4 - Normalized On-Resistance vs. Temperature

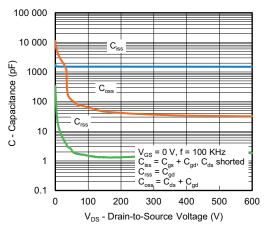


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

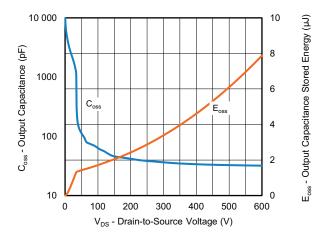


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



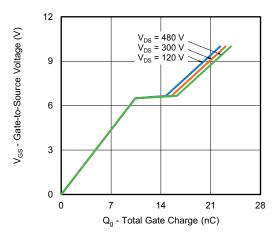


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

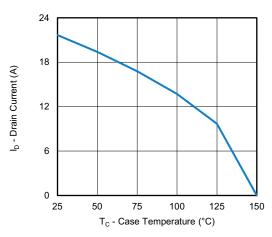


Fig. 9 - Maximum Drain Current vs. Case Temperature

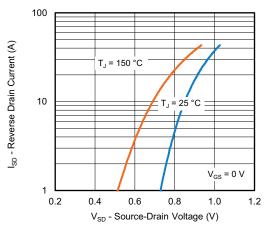


Fig. 8 - Typical Source-Drain Diode Forward Voltage

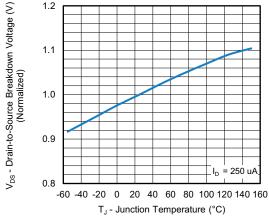


Fig. 10 - Temperature vs. Drain-to-Source Voltage

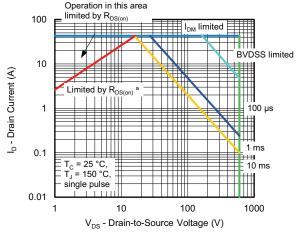


Fig. 11 - Maximum Safe Operating Area

## Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



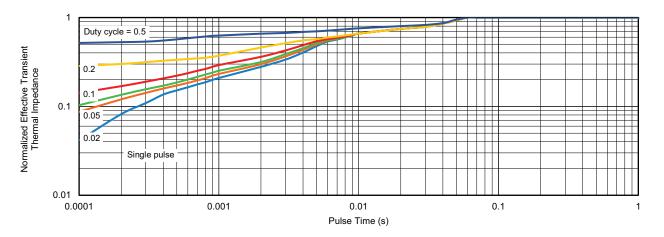


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

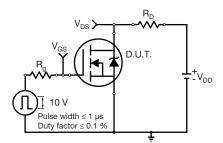


Fig. 13 - Switching Time Test Circuit

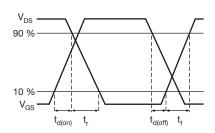


Fig. 14 - Switching Time Waveforms

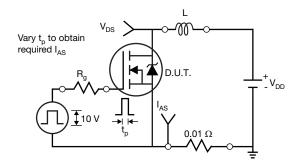


Fig. 15 - Unclamped Inductive Test Circuit

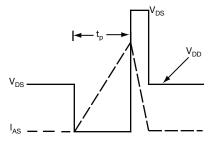


Fig. 16 - Unclamped Inductive Waveforms

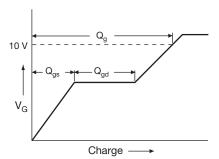


Fig. 17 - Basic Gate Charge Waveform

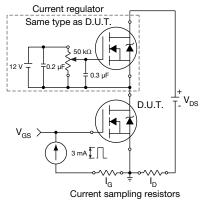
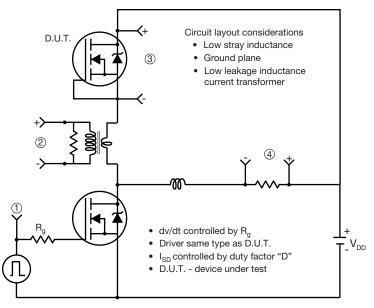


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dv/dt Test Circuit



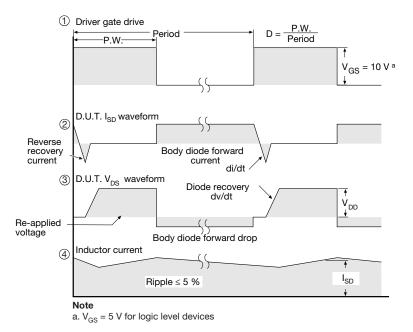


Fig. 19 - For N-Channel

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